

Global Ultra-Thin Copper Foil for IC Board Market 2026 by Manufacturers, Regions, Type and Application, Forecast to 2032

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Abstracts

According to our (Global Info Research) latest study, the global Ultra-Thin Copper Foil for IC Board market size was valued at US\$ 2346 million in 2025 and is forecast to a readjusted size of US\$ 5257 million by 2032 with a CAGR of 12.2% during review period.

Ultra-Thin Copper Foil for IC Board refers to high-precision electrodeposited copper foil specifically engineered for integrated circuit (IC) substrate and advanced package substrate applications, featuring extremely low thickness, ultra-smooth surface morphology, and highly controlled crystal structure to support ultra-fine line patterning and high-density interconnection in semiconductor packaging. It provides excellent electrical conductivity, minimal surface roughness, and superior dimensional stability, ensuring signal integrity and reliability in high-frequency and high-speed IC substrates. Production in 2025 totaled 108,571 tons with an average price of \$21,000/ton. The upstream primarily includes high-purity cathode copper and copper sulfate solution, with representative suppliers such as Jiangxi Copper, Tongling Nonferrous Metals, and Freeport-McMoRan. The midstream focuses on precision electrolytic fabrication and advanced surface treatment technologies, emphasizing thickness control, crystal structure optimization, and ultra-low roughness to meet stringent IC substrate manufacturing requirements. The downstream mainly serves computer and server systems, consumer electronics, and automotive electronics sectors, with major customers including Apple, Dell, HP, Huawei, Tesla, and BYD. In 2025, the industry's capacity utilization rate reached 93%, while the average gross margin was approximately 30%, reflecting strong demand from advanced packaging and solid profitability across the sector.

This report is a detailed and comprehensive analysis for global Ultra-Thin Copper Foil for IC Board market. Both quantitative and qualitative analyses are presented by manufacturers, by region & country, by Type and by Application. As the market is constantly changing, this report explores the competition, supply and demand trends, as well as key factors that contribute to its changing demands across many markets. Company profiles and product examples of selected competitors, along with market share estimates of some of the selected leaders for the year 2025, are provided.

Key Features:

Global Ultra-Thin Copper Foil for IC Board market size and forecasts, in consumption value (\$ Million), sales quantity (Tons), and average selling prices (US\$/Ton), 2021-2032

Global Ultra-Thin Copper Foil for IC Board market size and forecasts by region and country, in consumption value (\$ Million), sales quantity (Tons), and average selling prices (US\$/Ton), 2021-2032

Global Ultra-Thin Copper Foil for IC Board market size and forecasts, by Type and by Application, in consumption value (\$ Million), sales quantity (Tons), and average selling prices (US\$/Ton), 2021-2032

Global Ultra-Thin Copper Foil for IC Board market shares of main players, shipments in revenue (\$ Million), sales quantity (Tons), and ASP (US\$/Ton), 2021-2026

The Primary Objectives in This Report Are:

To determine the size of the total market opportunity of global and key countries

To assess the growth potential for Ultra-Thin Copper Foil for IC Board

To forecast future growth in each product and end-use market

To assess competitive factors affecting the marketplace

This report profiles key players in the global Ultra-Thin Copper Foil for IC Board market based on the following parameters - company overview, sales quantity, revenue, price, gross margin, product portfolio, geographical presence, and key developments. Key

companies covered as a part of this study include Mitsui Kinzoku, Furukawa Electric, JX Nippon Mining & Metal, Fukuda Metal Foil & Powder, Solus Advanced Materials, Jiangxi JCC Copper Foil, Jiujiang Defu, Hubei Zhongyi Technology, Nan Ya Plastics Corporation, Kingboard, etc.

This report also provides key insights about market drivers, restraints, opportunities, new product launches or approvals.

Market Segmentation

Ultra-Thin Copper Foil for IC Board market is split by Type and by Application. For the period 2021-2032, the growth among segments provides accurate calculations and forecasts for consumption value by Type, and by Application in terms of volume and value. This analysis can help you expand your business by targeting qualified niche markets.

Market segment by Type

Standard Copper Foil

RTF Copper Foil

VLP Copper Foil

Others

Market segment by Thickness

9-12µm

12-16µm

Market segment by Elongation

12-16%

16-20%

Others

Market segment by Application

Computers and Servers

Consumer Electronics

Automotive Electronics

Others

Major players covered

Mitsui Kinzoku

Furukawa Electric

JX Nippon Mining & Metal

Fukuda Metal Foil & Powder

Solus Advanced Materials

Jiangxi JCC Copper Foil

Jiujiang Defu

Hubei Zhongyi Technology

Nan Ya Plastics Corporation

Kingboard

Jiayuan Technology

Market segment by region, regional analysis covers

North America (United States, Canada, and Mexico)

Europe (Germany, France, United Kingdom, Russia, Italy, and Rest of Europe)

Asia-Pacific (China, Japan, Korea, India, Southeast Asia, and Australia)

South America (Brazil, Argentina, Colombia, and Rest of South America)

Middle East & Africa (Saudi Arabia, UAE, Egypt, South Africa, and Rest of Middle East & Africa)

The content of the study subjects, includes a total of 15 chapters:

Chapter 1, to describe Ultra-Thin Copper Foil for IC Board product scope, market overview, market estimation caveats and base year.

Chapter 2, to profile the top manufacturers of Ultra-Thin Copper Foil for IC Board, with price, sales quantity, revenue, and global market share of Ultra-Thin Copper Foil for IC Board from 2021 to 2026.

Chapter 3, the Ultra-Thin Copper Foil for IC Board competitive situation, sales quantity, revenue, and global market share of top manufacturers are analyzed emphatically by landscape contrast.

Chapter 4, the Ultra-Thin Copper Foil for IC Board breakdown data are shown at the regional level, to show the sales quantity, consumption value, and growth by regions, from 2021 to 2032.

Chapter 5 and 6, to segment the sales by Type and by Application, with sales market share and growth rate by Type, by Application, from 2021 to 2032.

Chapter 7, 8, 9, 10 and 11, to break the sales data at the country level, with sales quantity, consumption value, and market share for key countries in the world, from 2021 to 2026. and Ultra-Thin Copper Foil for IC Board market forecast, by regions, by Type, and by Application, with sales and revenue, from 2027 to 2032.

Chapter 12, market dynamics, drivers, restraints, trends, and Porters Five Forces analysis.

Chapter 13, the key raw materials and key suppliers, and industry chain of Ultra-Thin Copper Foil for IC Board.

Chapter 14 and 15, to describe Ultra-Thin Copper Foil for IC Board sales channel, distributors, customers, research findings and conclusion.

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